

HSF

NOTES:

Current Rating:1.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

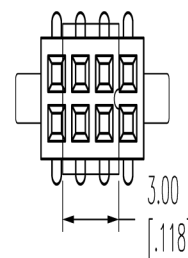
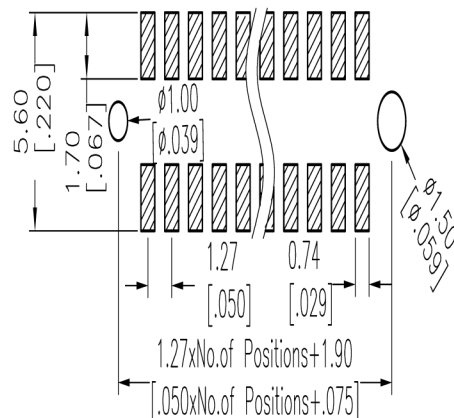
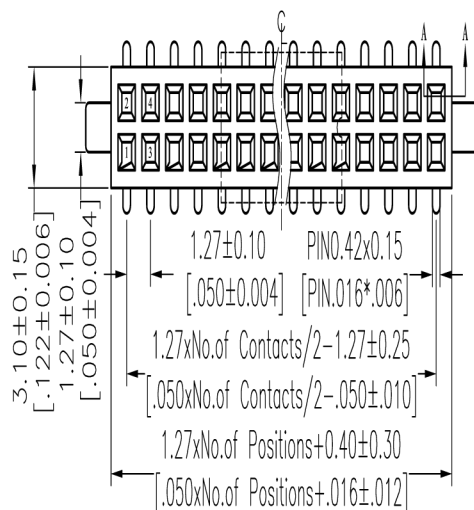
Operation Temperature:-40℃ to +105℃

Contact Material:Phosphor Bronze

Contact plating:Au over Ni

Insulator Material:PA9T+30%GF UL94V-0

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



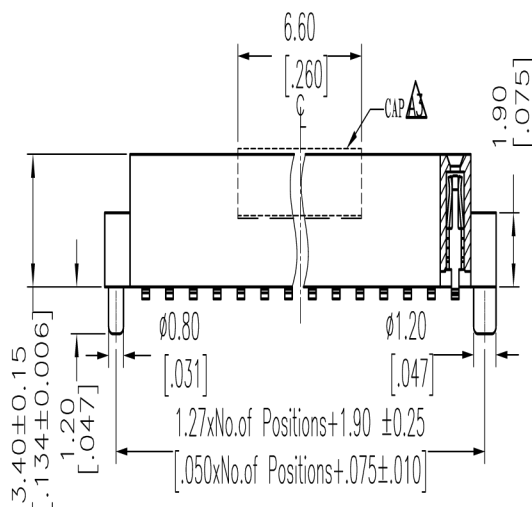
Ordering Information

2334-2 XX M XX CUN X 3

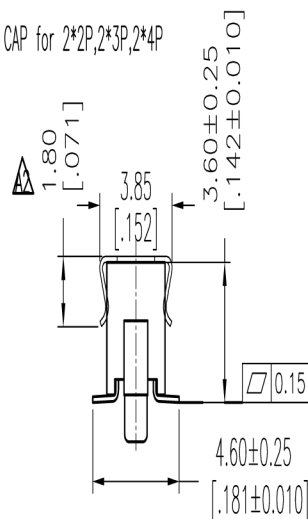
No. of Pins per Row: 02-50Pin

Contact Plating:
 G0=Gold Flash
 G3=10u"Gold
 G4=15u"Gold
 G5=30u"Gold

Packing:
 T=Tube
 P=Tube+CAP
 R=Tape&Reel+CAP



Special CAP for 2*2P,2*3P,2*4P



SECTION A-A

Item	Pitch	Mating
Standard	1.27	1310/1315/1320/3131
Alternate		

A3	2014/12/30	Modify CAP	-----	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2013/08/21	Modify cap.2.00 → 1.80	-----	X.X	±0.40	wang	UNIT	mm	2334-2XXMXXCUNX3
A1	2013/07/01	Modify drawing	-----	X.XX	±0.25	CHECK	SIZE	A4	TITLE:
A0	2012/07/06	NEW	-----	X.XXX	±0.15		SHEET	1/1	FH1. 27mm DUAL ROW 180° SMT WITH
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	± 3°	APPROVE	PROJ.	Customer NO.	DIFFERENT POST AND METAL CAP H=3.40
				DIM	TOL				

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